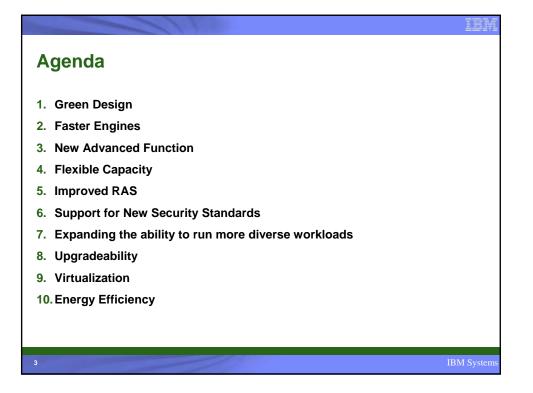
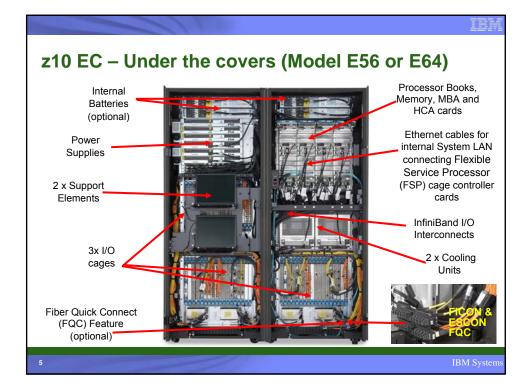
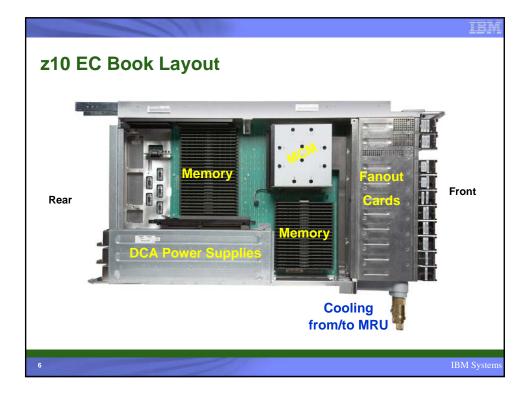


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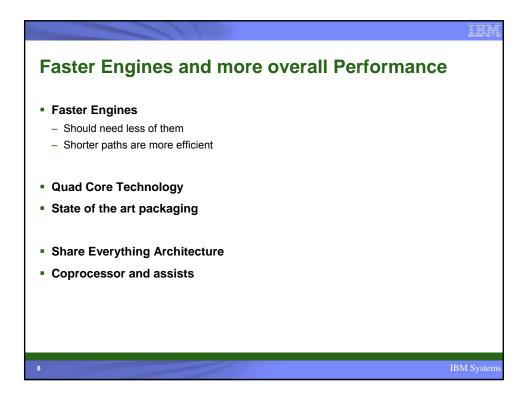


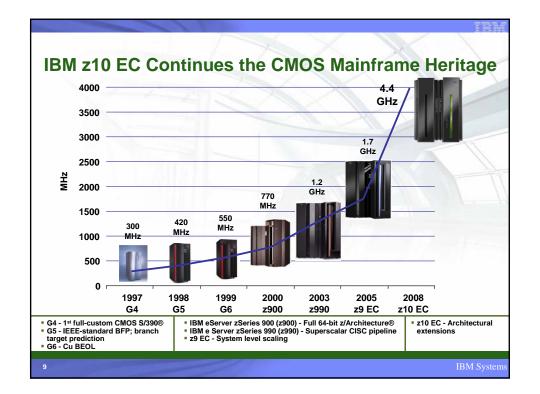
	Tem
Green Design	
■ Modular	
 Processor Book Package 	
 I/O cards 	
 High Efficiency Power Supplies 	
Variable Speed Energy Efficient Blowers	
Share Everything Architecture	
Deep Integration	
A masterpiece of HW, SW, microcode working in unison	
4	IBM Systems

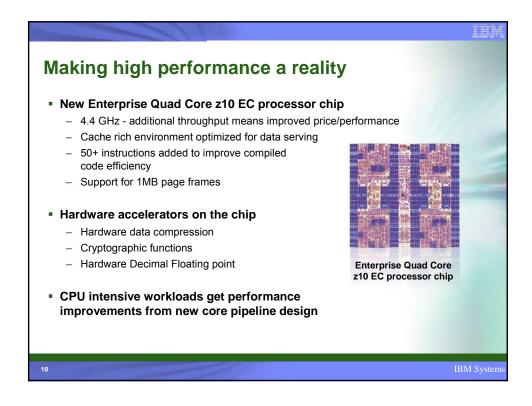




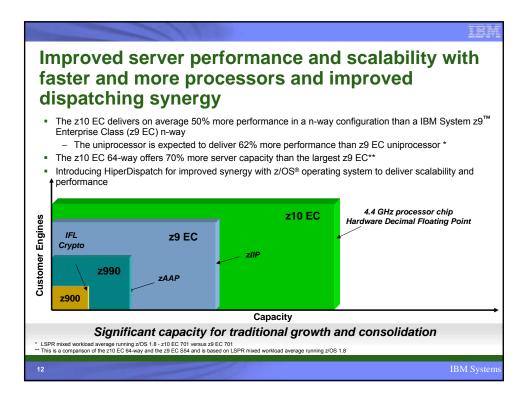




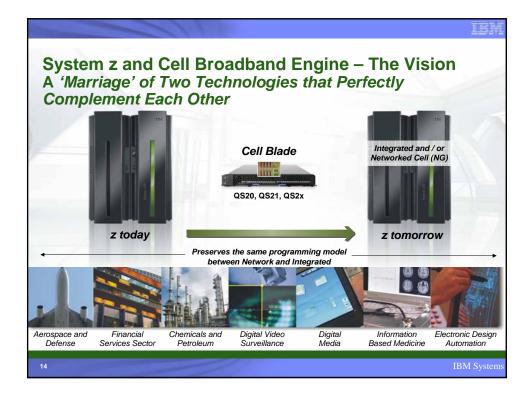


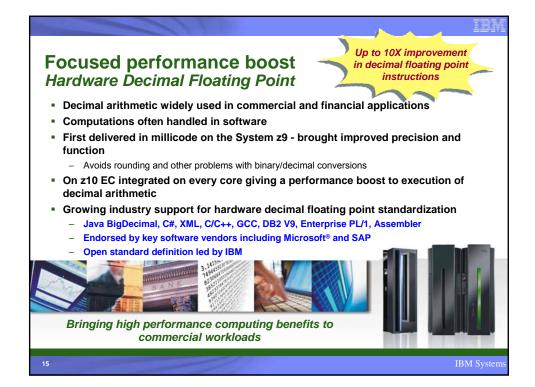




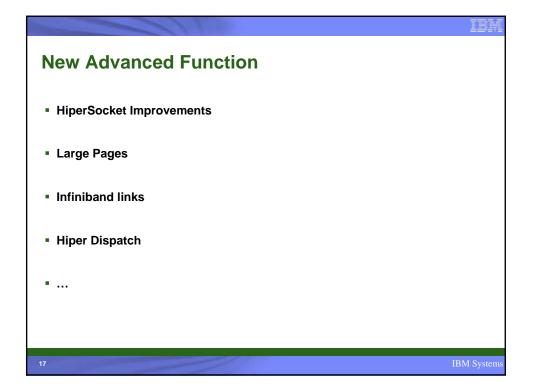


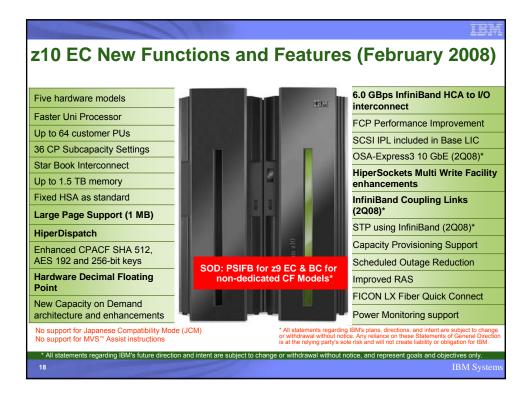


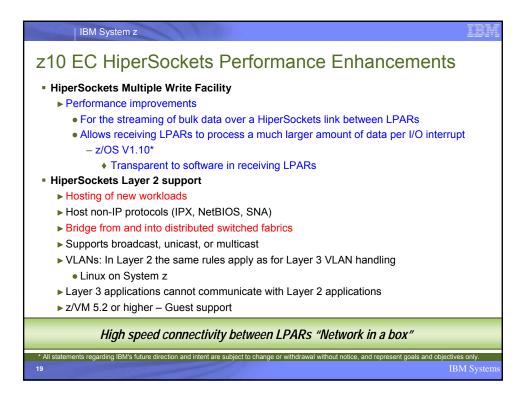




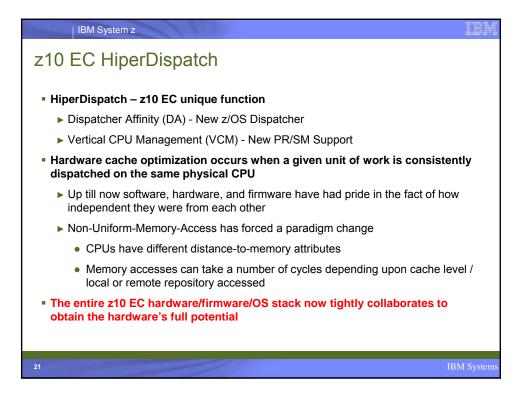
IBM System z		
z10 EC Hardware Decimal Floating Point Accelerator • Meets requirements of business and human-centric applications • Performance, Precision, Function		
Avoids rounding and other problems with binary/decimal conversions		
Improved numeric functionality over legacy Binary Coded Decimal (BCD) operations		
 Much of commercial computin operations 	g is dominated by decimal data and decimal	
	 IBM z10 EC Hardware Decimal Floating Point Unit co-developed (HDFU) with POWER6 Common architecture operations and semantics Common dataflow elements Mainframe legacy Binary Coded Decimal (BCD) operations mapped onto HDFU in z10 EC Growing industry support for DFP standardization Java BigDecimal, C#, XML, XL C/C++, GCC, DB2 , Enterprise PL/1, AssemblerEndorsed by key software vendors including Microsoft[®] and SAP Open standard definition led by IBM 	
Single PU Core		
16	IBM System	

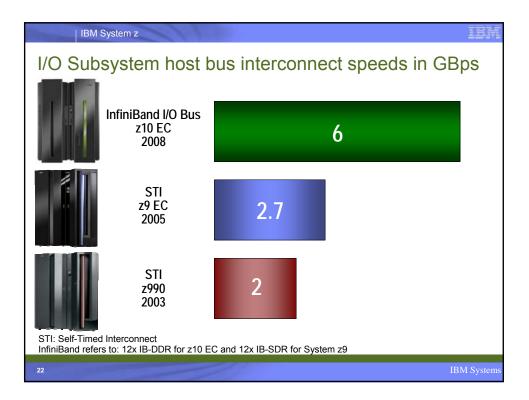


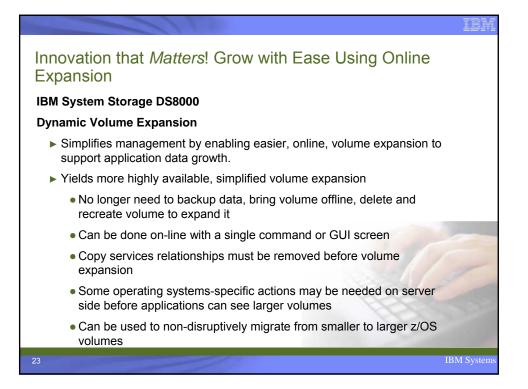


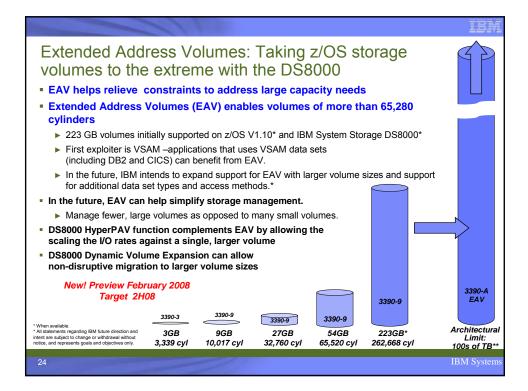


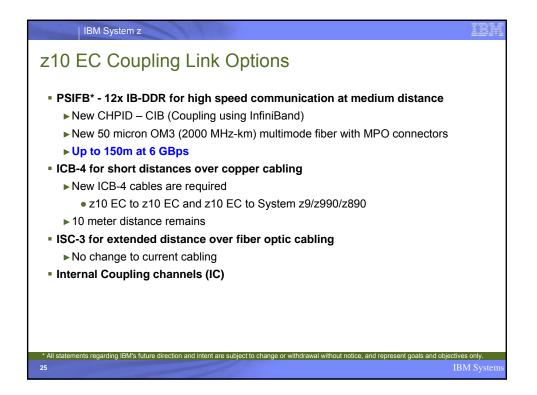
IBM System z	IBM
Large Page Performance Considerations	
 Large Page is a special purpose performance improvement feature. It is not recommended for general use. Large page usage provides performance valu select set of applications These are primarily long running memory access intensive applications 	ie to a
 Mese are primarily long running memory access mensive applications Not all applications benefit from using large pages. Some applications can b 	•
severely degraded by the use of large pages	e
 Short lived processes with small working sets are usually not good candidates large pages 	for
 Factors to consider when trying to either estimate the potential benefit or understand measured performance differences of using larger pages instead pages include: 	l of 4K
► Memory Usage	
A workload's page translation overhead	
Large Page Exploiters	
A future* release of DB2 will support Large Pages for bufferpools. Default is 4K	(pages
 Java 6.0 SR1 for z/OS is planned* to support Large Pages. Large pages can b to back the object heap. Default is 4K pages 	e used
* All statements regarding IBM's future direction and intent are subject to change or withdrawal without notice, and represent goals and objective	
20 [B]	M Systems



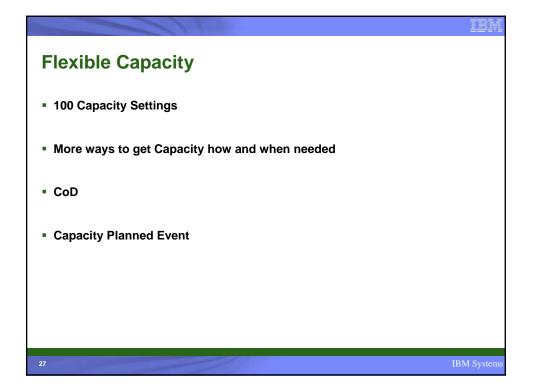


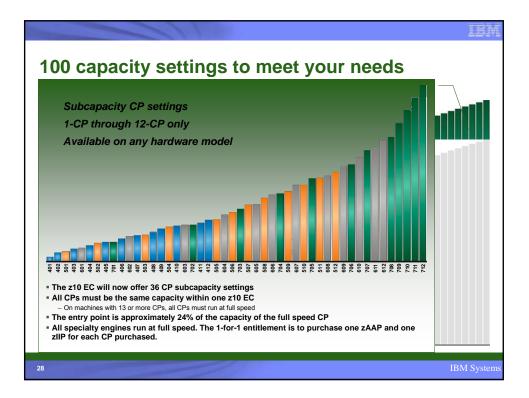


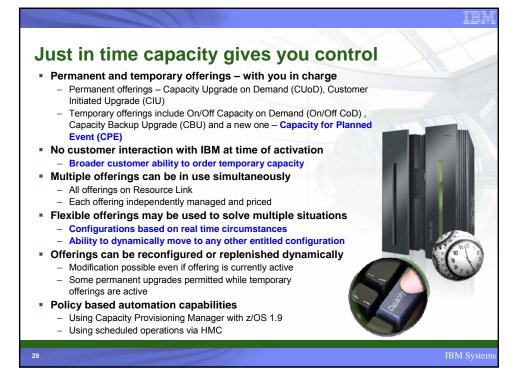




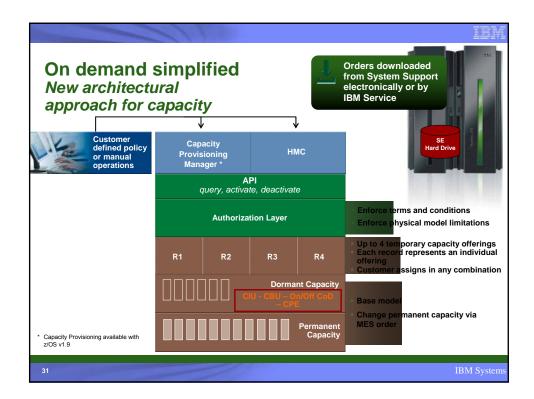
z10 EC fu	unctional co	omparison to z9 EC	
Processor / Memory	Uniprocessor Performance In-way Performance System Capacity Processor Design Models Processing Units (PUs) Granular Capacity Memory Fixed HSA	 62% performance improvement over z9 EC uniprocessor * On average 50% more performance than z9 EC in a n-way configur 70% system capacity performance improvement over z9 EC 54-way New 4.4GHz processor chip z10 EC has 5 and z9 EC has 5 models, both with up to 4 books z10 EC has up to 64 PUs to configure, up to 54 on z9 EC z10 EC has up to 100 Capacity settings versus 78 on the z9 EC z10 EC has up to 1.5 T8 vs. up to 512 GB on z9 EC z10 EC has fixed 16 GB HSA, z9 EC had HSA carved from purchas 	, **
Virtualization	 LPARs HiperDispatch 	 z10 EC has up to 64 logical processors in an LPAR versus 54 on z5 z10 EC has HiperDispatch for improved synergy with z/OS Operatin scalability and performance 	EC ng System to deliver
Connectivity	HiperSockets FICON for SANs Total channels Internal I/O Bandwidth Enhanced I/O structure Coupling Cryptography LAN Connectivity	 z10 EC New HiperSockets Layer 2 and Multiple Write Facility Up to 336 FICON channels on z10 EC and 29 EC Same - Up to 1024 channels z10 EC has industry standard 6 GBps InfiniBand supports high spe high bandwidth versus 29 EC using 2.7 GBps Self Time Interconnet Star L2 Cache Book Interconnect versus Ring Topology interconnet Coupling with InfiniBand 1 - improved distance and potential cost sz Improved AES 192 and 256 and stronger hash algorithm with Secur (SHA-512) New OSA-Express³¹ for 10 Gigabit Ethernet connectivity 	t on z9 EC vings
On Demand / RAS	 Capacity Provisioning Mgr RAS Focus Just in Time deployment of Capacity 	 z10 EC & z/OS (1.9) for policy based advice and automation z10 EC can help eliminate preplanning required to avoid scheduled Capacity on Demand offerings CBU and On/Off CoD plus new Capare resident on z10 EC 	outages acity for Planned Events
	Monitoring ng z/OS 1.8 - z10 EC 701 versus z9 EC 7	z10 EC displays energy efficiency on SAD screens Utilizes IBM Systems Director Active Energy Manager for Linux on calculations and management of other servers that participate	
This is a comparison of the z10 EC 6	4-way and the z9 EC S54 and is based or	1 LSPR mixed workload average running z/OS 1.8 1 Pl;	anned availability 2Q08 IBM System



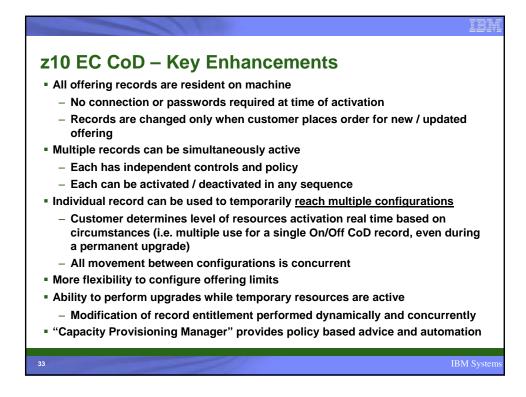


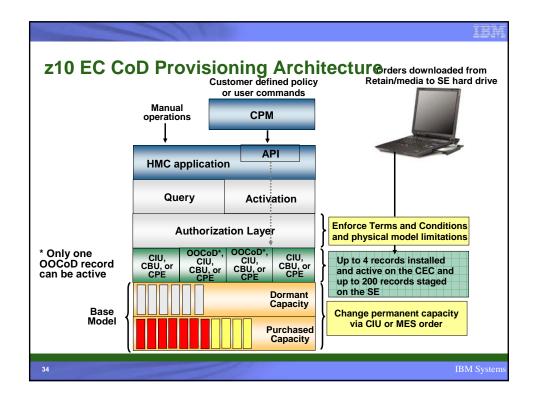


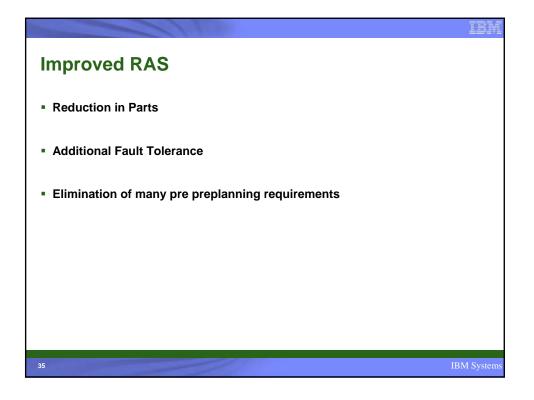


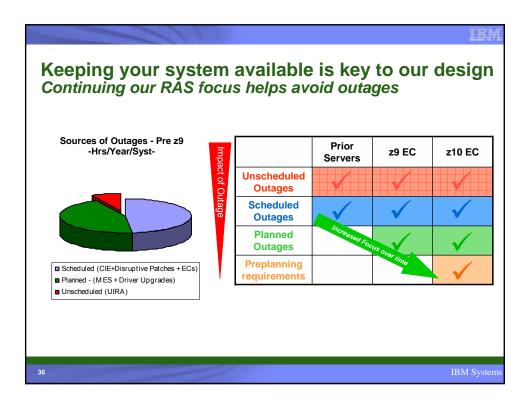


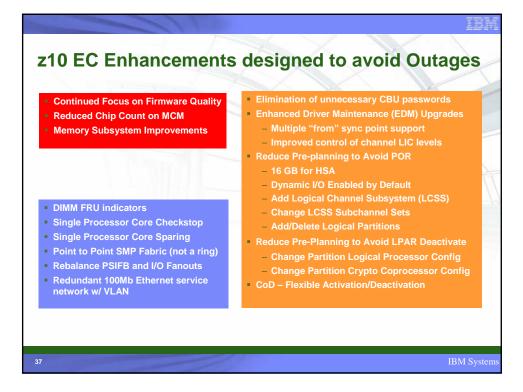
	IEM
z10 EC CoD Offerings - Details	
- CIU	
 Customer Initiated Upgrade for permanent increase in capacity 	
- CBU	
 For disaster recovery 	
 Capacity for Planned Event (CPE) 	
 To replace capacity lost within the enterprise due to a planned even such as a facility upgrade or system relocation 	ent
= OOCoD	
 Production Capacity 	
 Post-pay with unlimited capacity usage 	
32	IBM Systems
32	ibivi systellis

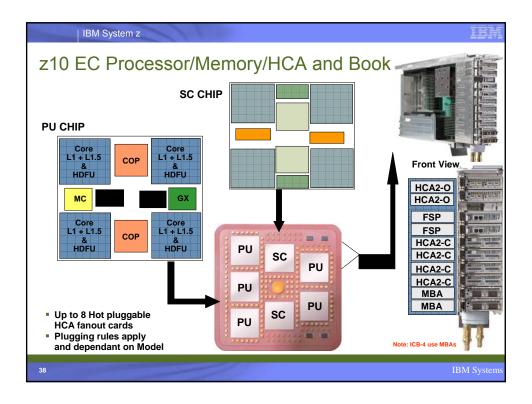


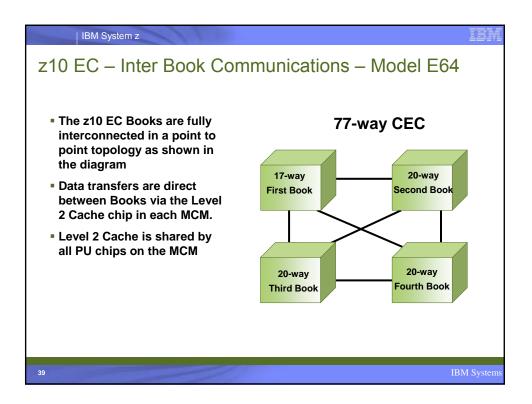




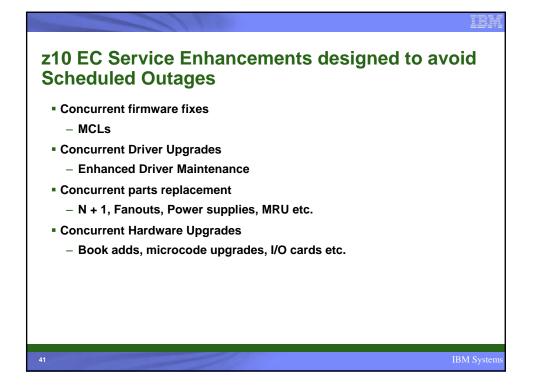


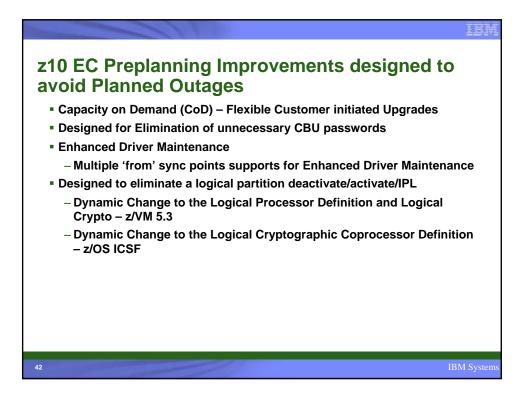


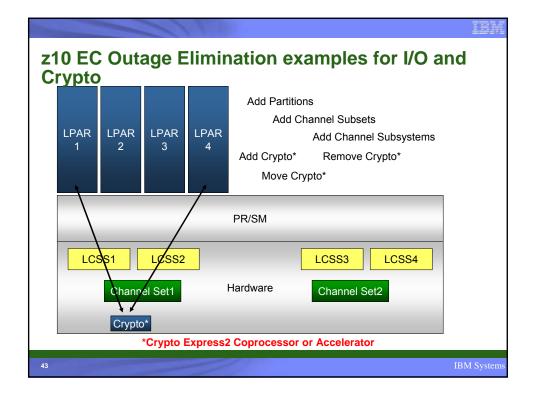


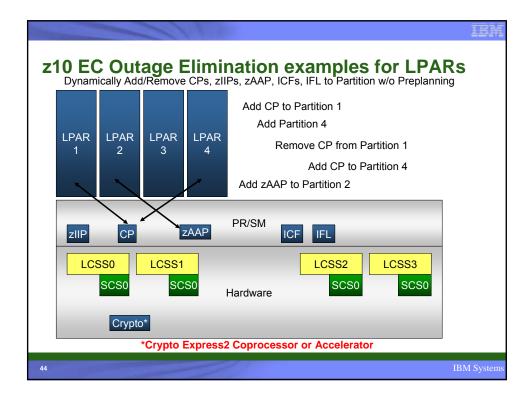


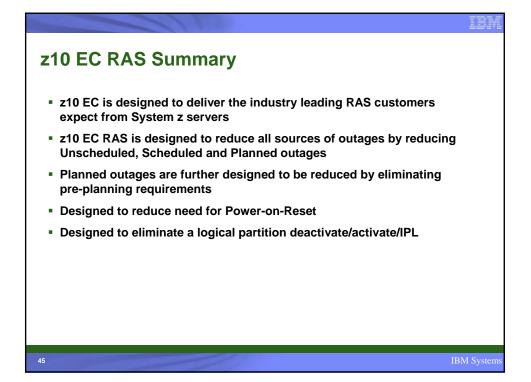


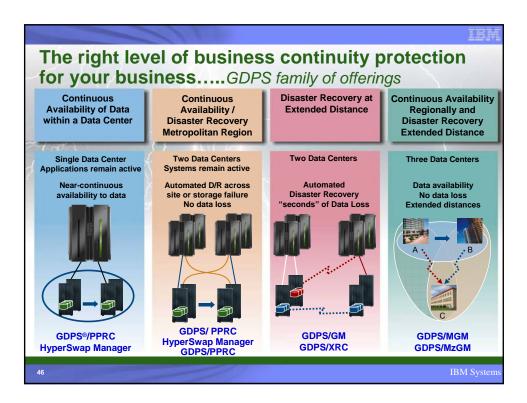




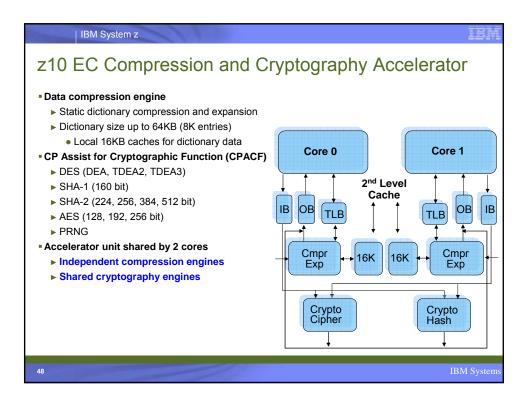












Encryption Authentication – Digital Certificate Authority on System z10

Customer Needs

49

- Deploy secure transactions and network connections
- Securely exchange encryption keys
- Manage the lifecycle of digital certificates

System z Value Proposition

- Save thousands to millions of dollars by replacing third party hosting of digital certificates
- · Full certificate life cycle management
- Highly available and highly secure

Saving costs

 Relatively low MIPS to drive thousands of certificates using no-cost feature of z/OS

Industry certification

 Certified by Identrust, a global leader in trusted identity solutions recognized by global financial institutions, government agencies and businesses

System z robustness

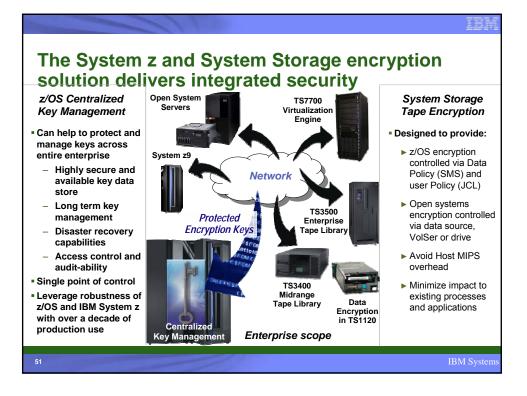
- Leverages resiliency and disaster recovery features
- Highly secure using mainframe access and audit controls and encryption features
 Services available to accelerate

New ISV support

Venafim solutions for centralized digital certificate management now support z/OS Certificate Authority

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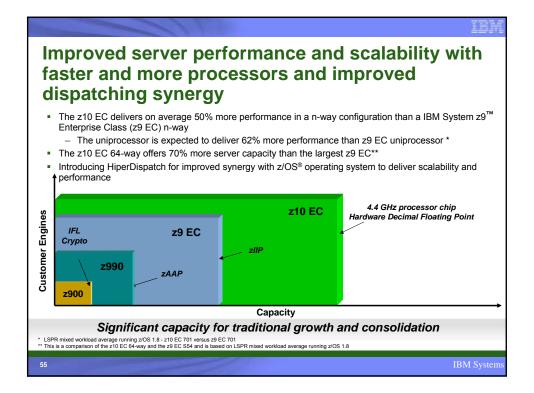




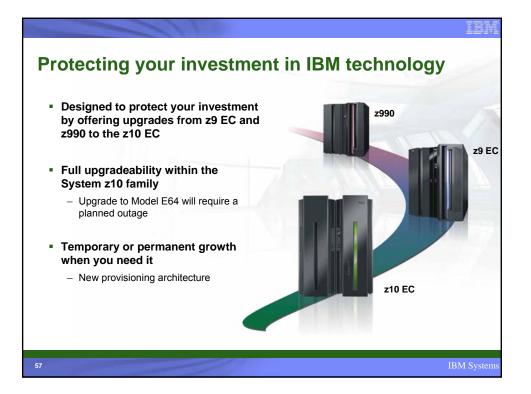


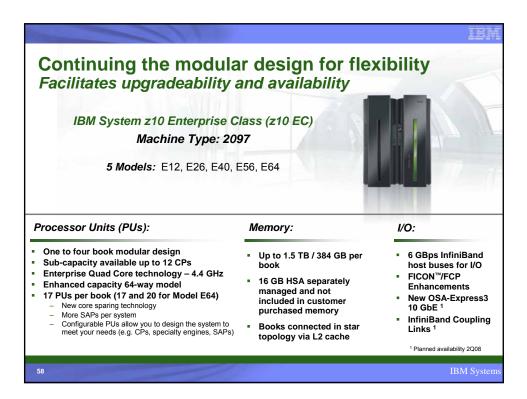


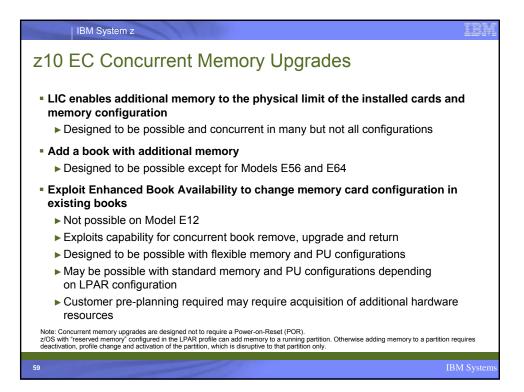




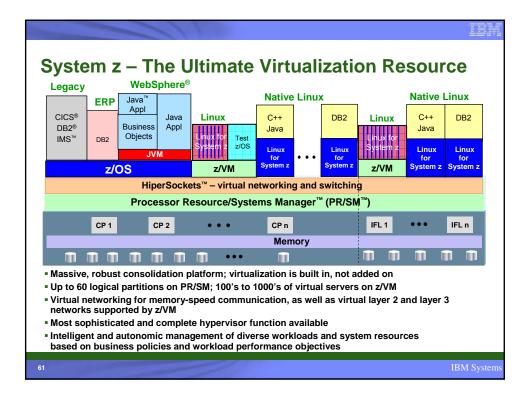


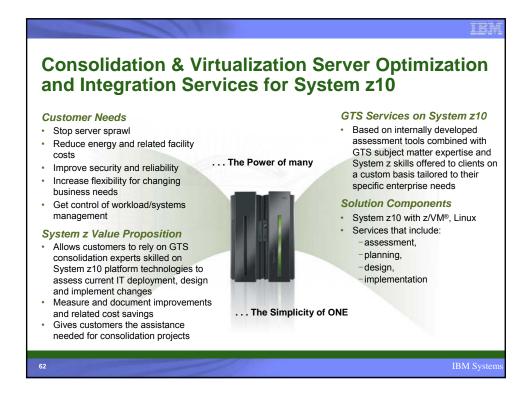


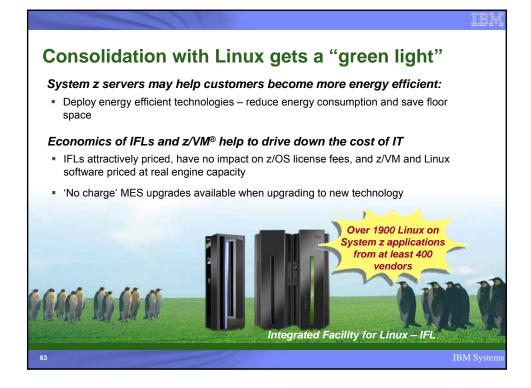


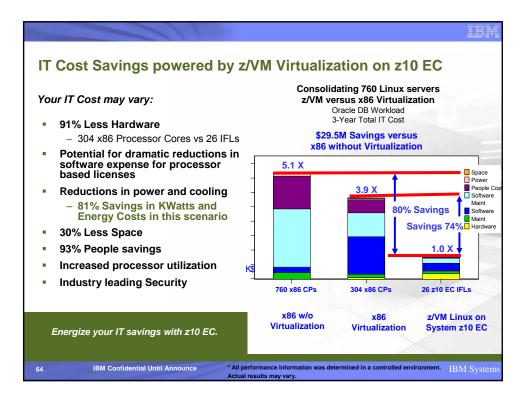




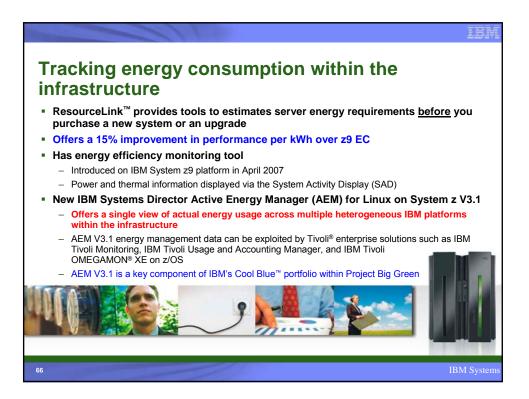


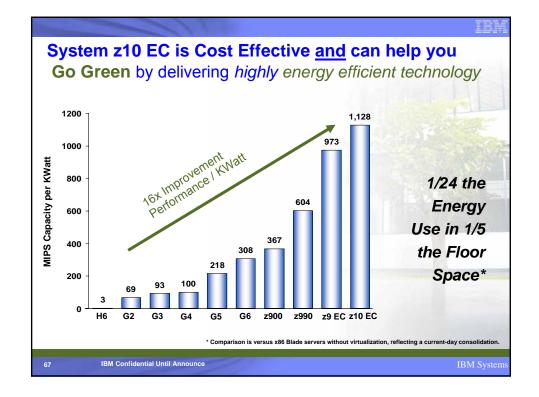




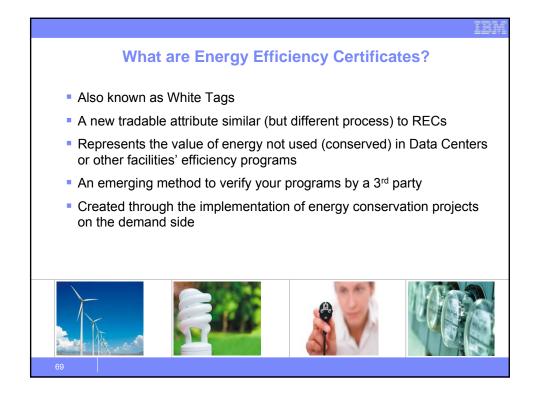


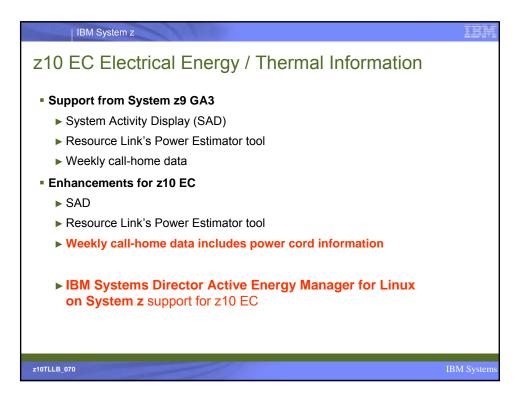


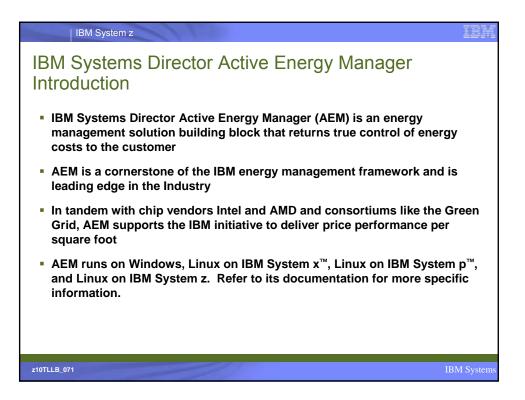




IBM System z	IEM	
System z Energy Efficiency		
Mainframe focus on system and data center efficiency		
Consolidation of many servers onto one system		
Consistent performance at sustained high utilization		
 Resilience in face of changing workloads 		
Leverages virtualization capabilities of PR/SM, z/VM, z/OS		
System z designs are optimized for scale-up data serving		
SMP Hub design enables robust scaling across wide spectrum of workloads		
Centralized SMP fabric minimizes fabric logic per core		
 Extended on z10 EC via 4-core processor chip 		
MRU cooling allows dense package and reduces leakage power		
Extensive hardware support for multi-level virtualization		
Chip-level power optimization applied to IBM z10 EC design		
Local clock gating to limit maximum dynamic power		
Millicode sleep mode for wait/spare/stop states		
z10TLLB_068	3M Systems	







	11	IBM	
IBM System z10 EC – 4 Steps to Maximizing your IT ROI			
个地产物	Lower the running costs of existing IT	Reduce the operating costs of existing workloads with the improved price performance and technology driven dividends of a new z10 EC mainframe.	
2	Manage growth, complexity and risk	Scalable products and solutions you can trust to more easily and securely manage the complex world of IT.	
3	Go green and save	Cut costs and "go green" with leadership energy-efficient hardware, consolidation and virtualization capabilities on System z10 EC	
	Realize innovation	Technology that makes innovation real in your business and sets you apart from the competition.	
72		IBM Systems	

The New Enterprise Data Center



IBM

- New economics: Virtualization breaks the lock between IT users and IT resources
- Rapid service delivery: Service management enables visibility, control and automation to deliver quality service at any scale
- Aligned with business goals: Real-time integration of transactions, information and analytics - and delivery of IT as a service

